EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	221	(semiconductor or electronic or circuit) same2 (solder\$3) same (wet\$4) with align\$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/11/26 16:18
L2	27	(semiconductor or electronic or circuit) same2 (solder\$3) same (wet\$4) with align\$5 same tension	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/11/26 16:38
L3	1	("2004/0089880").URPN.	USPAT	ADJ	ON	2008/11/26 16:40
S1	2	"20080011814"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 08:53
82	1405	((circuit or electronic) near (device or component or board)) same (rectangular or rectangle or square) with (pad)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 08:58
S3	855	S2 and solder\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 08:58
S4	90	"4404059"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 09:33
S5	89	"3801388"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 09:34

S 6	53	*5738797*	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 09:34
S7	11	("3801388" "4404059" "4561173" "5738797"). PN. OR ("6111204"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/07/24 09:35
S8	64	("3292240" "3303393" "3320658" "3339704" "3367476" "3373481" "3367476" "3373481" "3387465" "3461357" "3591839" "3461657" "3591839" "34646670" "3780352" "3795047" "3871015" "3975216" "4231154" "4251852" "4231754" "4251852" "4430288" "4512509" "4517051" "454610" "4549200" "4628408" "4642889" "4646435" "4681654" "4692843" "4857671" NR ("5170931")	US-PGPUB; USPAT; USOOR	ADJ	ON	2008/07/24 13:27
S9	14	("20010029095" "20020034872" "20040087130" "20040087130" "20040175917" "20040209452" "6297142" "6413850" "6564986" "6686736" "6846735" "6884707" "6897141" "7078330"). PN. OR ("7217645").	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/07/24 13:39
S10	1405	((circuit or electronic) near (device or component or board)) same (rectangular or rectangle or square) with (pad)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 13:58
S11	855	S10 and solder\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM TDB	ADJ	ON	2008/07/24 13:58

S12	78	S11 and (orthogonal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 13:58
S13	2	"20080011814"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 14:32
S14	1	S13 and h	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 14:32
S15	1	(US-5170931-\$).did.	USPAT	ADJ	ON	2008/07/24 14:33
S16	1	S15 and h	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 14:33
Si7	965	(solder\$3 or bond\$3) near1 pad same (different or multi or multiple) with size	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24
S18	474	(solder\$3 or bond\$3) near1 pad same (different or multi or multiple) near1 size	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 14:38
S19	2	"20010020747"	US-PCPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 14:52
S20	1	S15 and square	USPAT	ADJ	ON	2008/07/24 15:00
S21	51	S12 and force	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 15:02

322	50	(("20030095755") or	US-PGPUB;	OR	OFF	2008/07/24
OL L		("20040070400") or	USPAT; USOCR	1	0	15:16
	i	("20040114259") or	00/711, 000011			10.10
		("20050279170") or				
	i	("20060228066") or				
	i	("20060246630") or				
	1	("4274824") or				
	i	("4283278") or				
	i	("4317699") or				
	i	("4323979") or				
	i	("4330911") or				
	i	("4336470") or				
	i	("4339290") or				
		("4350276") or				
	i	("4364160") or				
		("4382749") or				
		("4384236") or				
	i	("4408092") or				
	i	("4416562") or				
	1	("4419816") or				
		("4430793") or				
		("4431267") or				
		("4432038") or				
		("4432587") or				
		("4440462") or				
	i	("4443168") or				
	1	("4453838") or				
		("4458958") or				
		("4472668") or				
		("4491078") or				
	i	("4498731") or				
		("4500274") or				
	i	("4512674") or				
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		("4558620") or			-	
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		("4959005") or				
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		("6019212") or				
		("6084782") or				
	1	("6169827") or				
		("6287765") or				
		("6860648") or			***	
		("6998851") or			***	
	*	("7002730")).PN.				
	\$	A . 102.00 //	3	3	3	1

S23	2	(electronic or circuit) near1 (chip or component or board) same ((solder or bond\$3) near1 pad) with (different or multiple or multi) near1 (size) and force	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 15:18
S24	15	(electronic or circuit) near1 (chip or component or board) same ((solder or bond\$3) near1 pad) same (different or multiple or multi) near1 (size) and force	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 15:19
S2 5	54	(electronic or circuit) near1 (chip or component or board) same ((solder or bond\$3) near1 pad) same (different or multiple or multi) near1 (size)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 15:21
S 26	97	(oggioni or albrecht or despont or lantz or castriotta).inv. and ((pad) and (component or chip) and solder)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 16:02
S 27	379	S11 and (force or press)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 16:16
S28	85	S11 and (spacer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 16:24
S2 9	15	S11 and (stopper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 16:30
S30	3	(("2002119597") or ("6125043") or ("2001033718") or ("4600970") or ("6239385")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/07/24 16:39

S31	5380	(MEMS or electronic component or electronic chip or semiconductor) and solder and (press or force) and (stopper or spacer)	US PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 17:47
S32	1481	(MEMS or electronic component or electronic chip or semiconductor) and solder and (press or force) same (stopper or spacer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 17:47
S33	624	(MEMS or electronic component or electronic chip or semiconductor) same solder and (press or force) same (stopper or spacer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/24 17:48
S34	0	("2004/0251540").URPN.	USPAT	ADJ	ON	2008/07/24 17:59
S 35	4	(("6125043") or ("6239385") or ("20020119597") or ("20010033718")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/07/24 18:02
S3 6	26	("3436615" "3811186" "4184043" "5011066" "5220200" "5311399" "5519580" "5889326" "5929521" "5968670"). PN. OR ("6125043"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/07/24 18:03
S 37	1	("6125043").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/07/25 10:47
S38	389	(electronic component and solder pad and solder and press)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/25 10:48
S39	890	thermo\$1compression near (bond\$3) same (electronic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/25 11:00

^{11/26/2008 4:50:30} PM

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